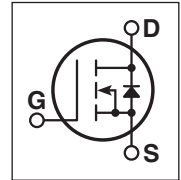
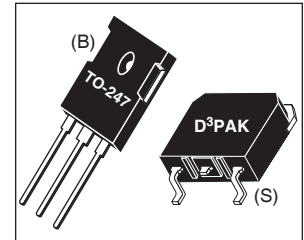




## Super Junction FREDFET



- Ultra Low  $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge,  $Q_g$
- Avalanche Energy Rated
- Extreme  $dv/dt$  Rated
- Intrinsic Fast-Recovery Body Diode
- Extreme Low Reverse Recovery Charge
- Ideal For ZVS Applications
- Popular TO-247 or Surface Mount D<sup>3</sup> Package

### MAXIMUM RATINGS

 All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	APT47N60B_SCF(G)	UNIT
$V_{DSS}$	Drain-Source Voltage	600	Volts
$I_D$	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	46	Amps
	Continuous Drain Current @ $T_C = 100^\circ\text{C}$	29	
$I_{DM}$	Pulsed Drain Current <sup>①</sup>	115	
$V_{GS}$	Gate-Source Voltage Continuous	±30	Volts
$P_D$	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	417	Watts
	Linear Derating Factor	1.67	W/°C
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	°C
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	260	
$dv/dt$	Drain-Source Voltage slope ( $V_{DS} = 480\text{V}$ , $I_D = 46\text{A}$ , $T_J = 125^\circ\text{C}$ )	80	V/ns
$I_{AR}$	Avalanche Current <sup>②</sup>	20	Amps
$E_{AR}$	Repetitive Avalanche Energy <sup>②</sup>	1	mJ
$E_{AS}$	Single Pulse Avalanche Energy <sup>③</sup>	1800	

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$B_{(VR)DS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$ )	600			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance <sup>④</sup> ( $V_{GS} = 10\text{V}$ , $I_D = 29\text{A}$ )			0.083	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 600\text{V}$ , $V_{GS} = 0\text{V}$ )			6	$\mu\text{A}$
	Zero Gate Voltage Drain Current ( $V_{DS} = 600\text{V}$ , $V_{GS} = 0\text{V}$ , $T_C = 150^\circ\text{C}$ )			5000	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$ )			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 2.9\text{mA}$ )	3	4	5	Volts

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

 APT Website - <http://www.advancedpower.com>

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**DYNAMIC CHARACTERISTICS**

**APT47N60BCF\_SCF(G)**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		7290		pF
$C_{oss}$	Output Capacitance			1735		
$C_{rss}$	Reverse Transfer Capacitance			41		
$Q_g$	Total Gate Charge <sup>⑤</sup>	$V_{GS} = 10V$ $V_{DD} = 300V$ $I_D = 46A @ 25^\circ C$		255		nC
$Q_{gs}$	Gate-Source Charge			43		
$Q_{gd}$	Gate-Drain ("Miller") Charge			135		
$t_{d(on)}$	Turn-on Delay Time	<b>RESISTIVE SWITCHING</b> $V_{GS} = 15V$ $V_{DD} = 380V$ $I_D = 46A @ 25^\circ C$ $R_G = 3.6\Omega$		30		ns
$t_r$	Rise Time			30		
$t_{d(off)}$	Turn-off Delay Time			100		
$t_f$	Fall Time			15		
$E_{on}$	Turn-on Switching Energy <sup>⑥</sup>	<b>INDUCTIVE SWITCHING @ 25°C</b> $V_{DD} = 400V, V_{GS} = 15V$ $I_D = 46A, R_G = 4.3\Omega$		885		$\mu J$
$E_{off}$	Turn-off Switching Energy			590		
$E_{on}$	Turn-on Switching Energy <sup>⑥</sup>	<b>INDUCTIVE SWITCHING @ 125°C</b> $V_{DD} = 400V, V_{GS} = 15V$ $I_D = 46A, R_G = 4.3\Omega$		1270		
$E_{off}$	Turn-off Switching Energy			725		

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$I_S$	Continuous Source Current (Body Diode)			46	Amps
$I_{SM}$	Pulsed Source Current <sup>①</sup> (Body Diode)			115	
$V_{SD}$	Diode Forward Voltage <sup>④</sup> ( $V_{GS} = 0V, I_S = -46A$ )			1.2	Volts
$dv/dt$	Peak Diode Recovery $dv/dt$ <sup>⑦</sup>			40	V/ns
$t_{rr}$	Reverse Recovery Time ( $I_S = -46A, di/dt = 100A/\mu s$ )	$T_j = 25^\circ C$		210	ns
		$T_j = 125^\circ C$		350	
$Q_{rr}$	Reverse Recovery Charge ( $I_S = -46A, di/dt = 100A/\mu s$ )	$T_j = 25^\circ C$		2.0	$\mu C$
		$T_j = 125^\circ C$		5.4	
$I_{RRM}$	Peak Recovery Current ( $I_S = -46A, di/dt = 100A/\mu s$ )	$T_j = 25^\circ C$		18	Amps
		$T_j = 125^\circ C$		28	

**THERMAL CHARACTERISTICS**

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.30	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			62	

- ① Repetitive Rating: Pulse width limited by maximum junction temperature
- ② Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV} = E_{AR} * f$
- ③ Starting  $T_j = +25^\circ C, L = 36.0mH, R_G = 25\Omega, \text{Peak } I_L = 10A$
- ④ Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%
- ⑤ See MIL-STD-750 Method 3471
- ⑥  $E_{on}$  includes diode reverse recovery. See figures 18, 20.
- ⑦ Maximum 125 $^\circ C$  diode commutation speed =  $di/dt$  600A/ $\mu s$

APT Reserves the right to change, without notice, the specifications and information contained herein.

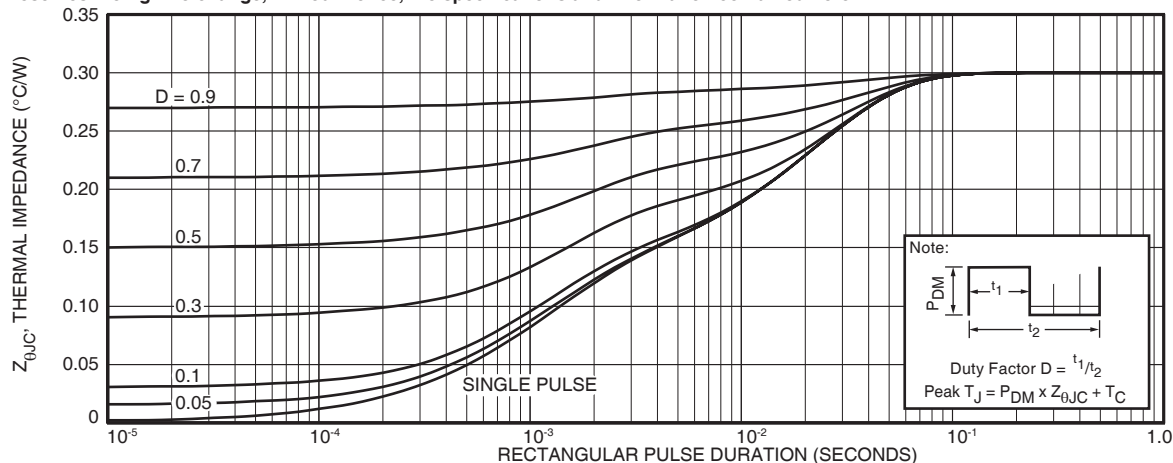


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

# Typical Performance Curves

APT47N60BCF\_SCF(G)

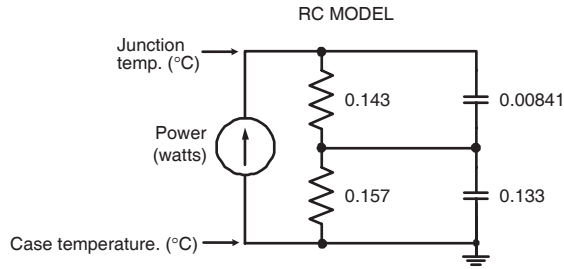


FIGURE 2, TRANSIENT THERMAL IMPEDANCE MODEL

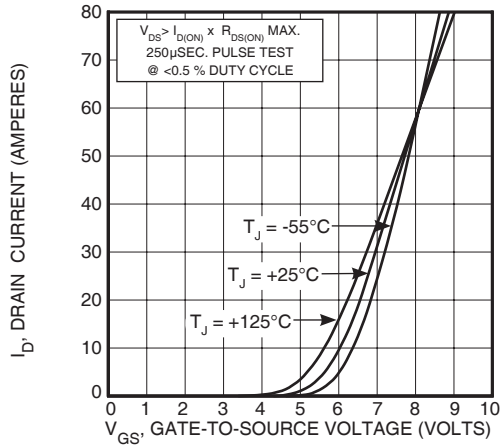


FIGURE 4, TRANSFER CHARACTERISTICS

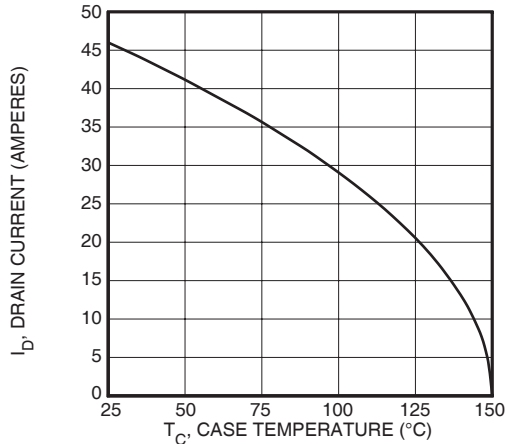


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

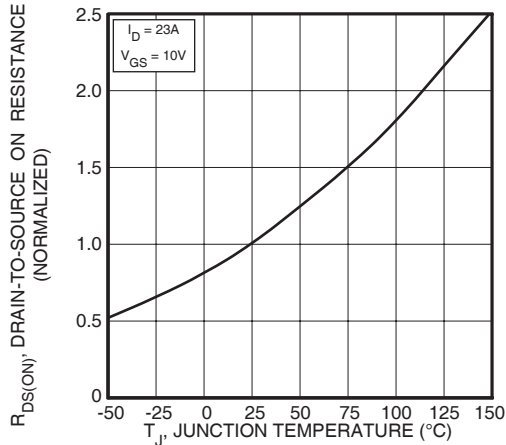


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

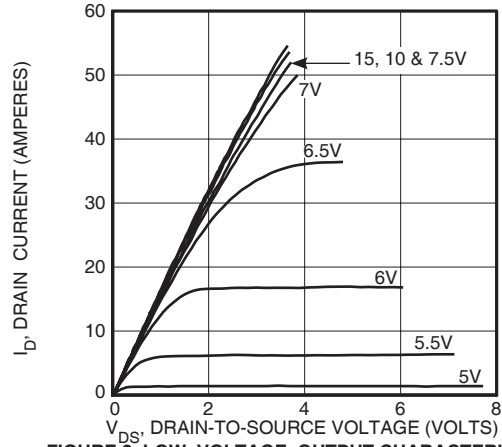


FIGURE 3, LOW VOLTAGE OUTPUT CHARACTERISTICS

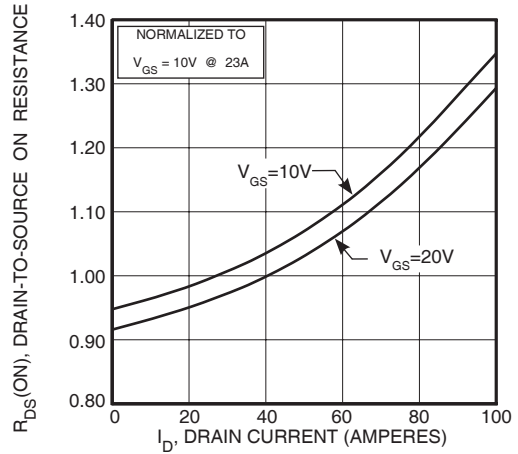


FIGURE 5,  $R_{DS(ON)}$  vs DRAIN CURRENT

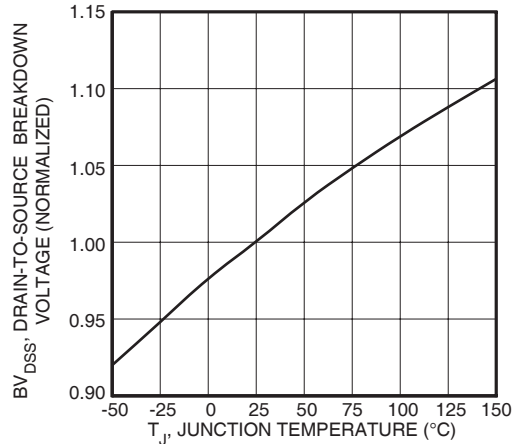


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

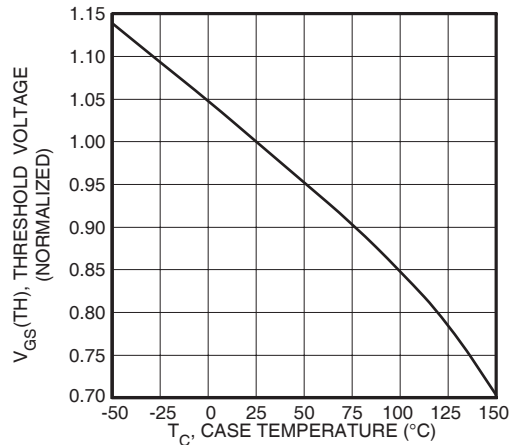


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

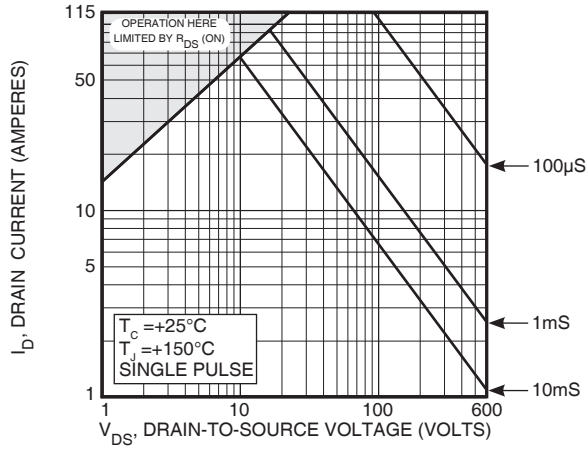


FIGURE 10, MAXIMUM SAFE OPERATING AREA

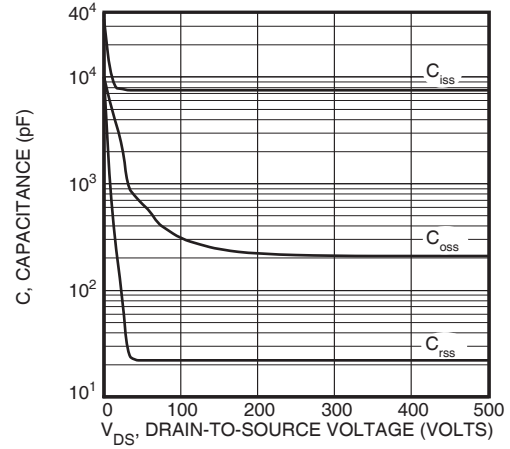


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

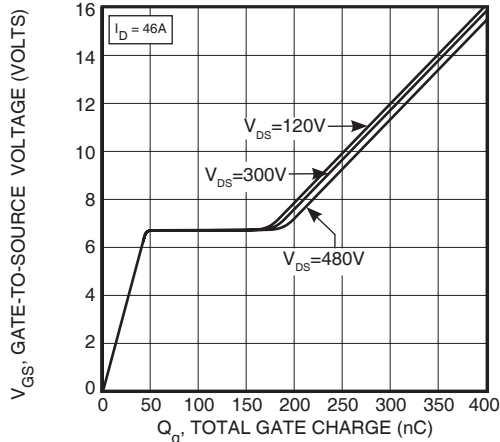


FIGURE 12, GATE CHARGE vs GATE-TO-SOURCE VOLTAGE

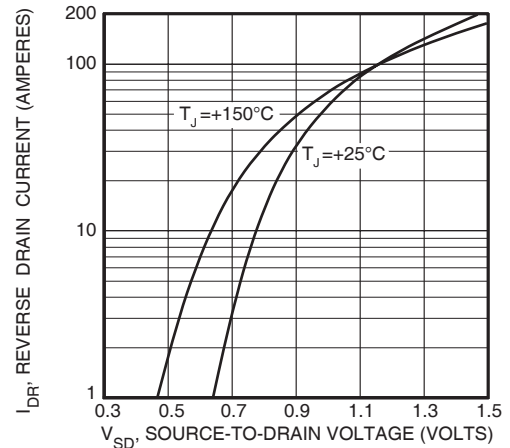


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

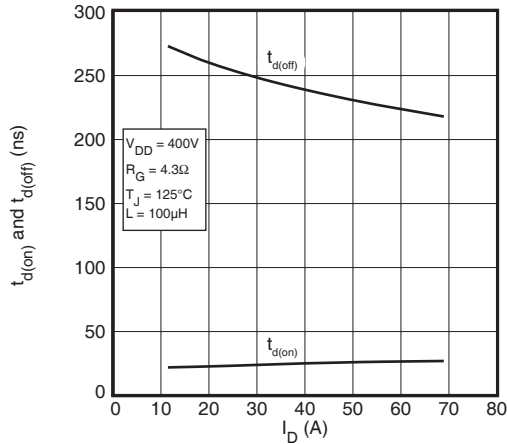


FIGURE 14, DELAY TIMES vs CURRENT

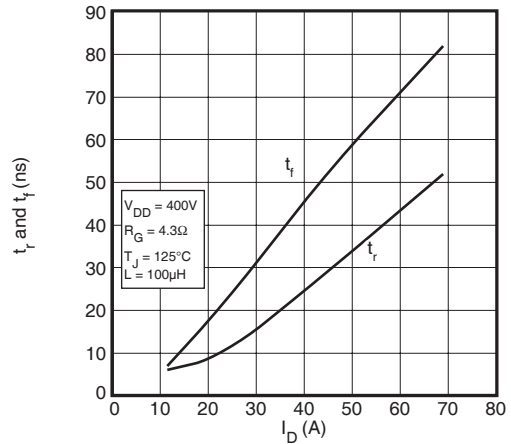


FIGURE 15, RISE AND FALL TIMES vs CURRENT

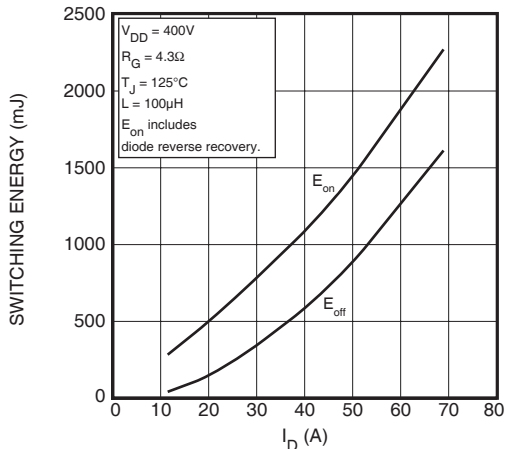


FIGURE 16, SWITCHING ENERGY vs CURRENT

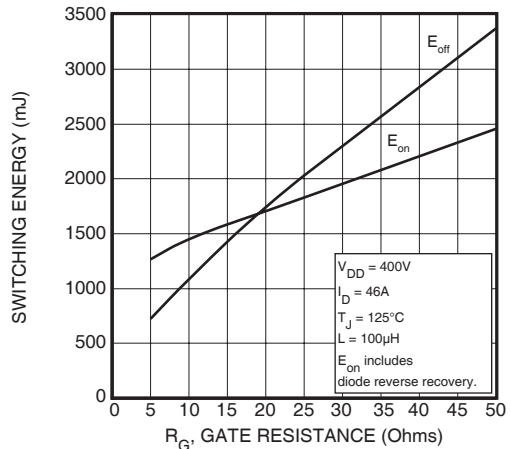


FIGURE 17, SWITCHING ENERGY vs. GATE RESISTANCE

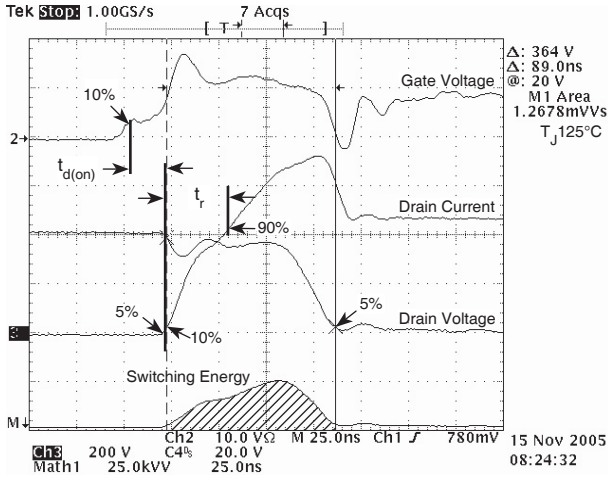


Figure 18, Turn-on Switching Waveforms and Definitions

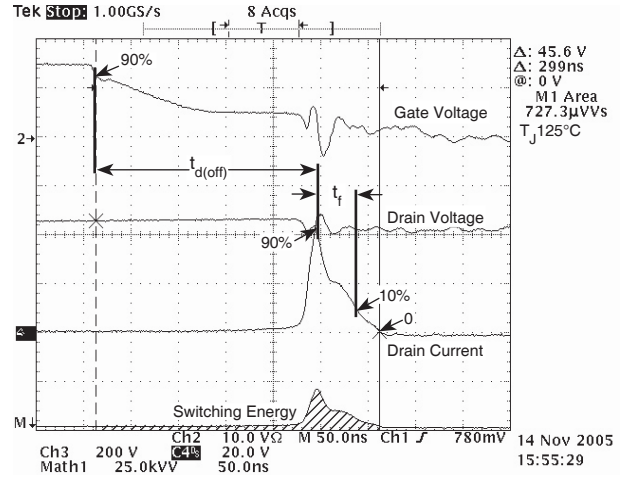


Figure 19, Turn-off Switching Waveforms and Definitions

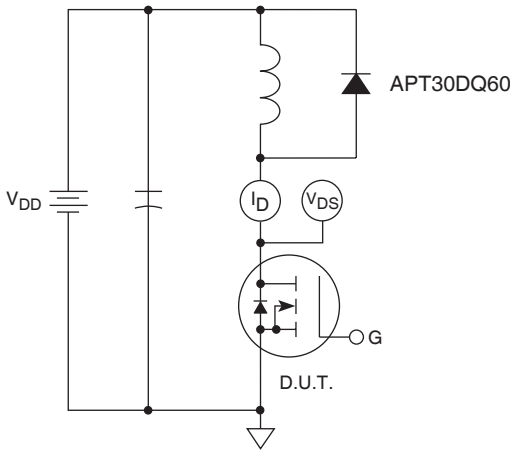
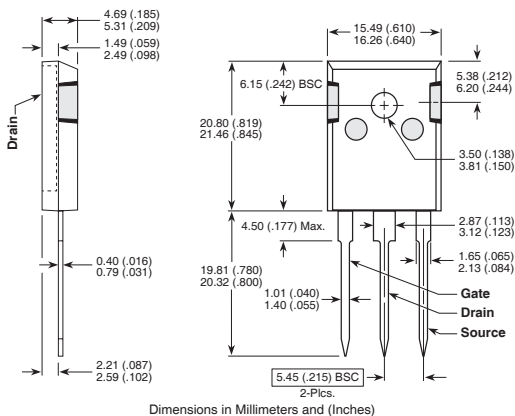


Figure 20, Inductive Switching Test Circuit

TO-247 Package Outline

e1 SAC: Tin, Silver, Copper



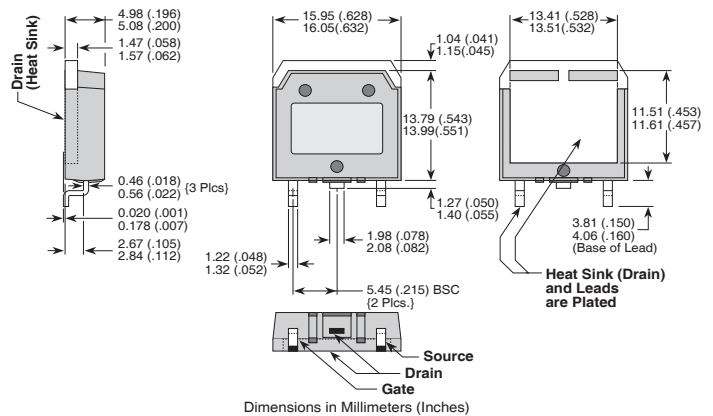
Dimensions in Millimeters and (Inches)

APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522

5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. US and Foreign patents pending. All Rights Reserved.

D<sup>3</sup>PAK Package Outline

e3 100% Sn



Dimensions in Millimeters and (Inches)